Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	6296	h05k003/38.ipc.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/17 09:09
L2	0	1 and (ptfe or teflon or polytetrafluoroethylene) and monomer and ((electroless or electrolessly) near3 (plate or plated or plating))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/17 09:11
L3		1 and (ptfe or teflon or polytetrafluoroethylene) and monomer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/17 09:17
L4	103	((circuit or wiring) near5 board) and (ptfe or teflon or polytetrafluoroethylene) and (monomer same (palladium or tin or seed))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/17 09:20
L5	104	((circuit or wiring or printed) near5 board) and (ptfe or teflon or polytetrafluoroethylene) and (monomer same (palladium or tin or seed))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/17 09:27
L6	13	((circuit or wiring or printed) near5 board) and (ptfe or teflon or polytetrafluoroethylene) and (monomer same (palladium or tin or seed)) and (((electro or electroless or electrolessly) near5 (plate or plated or plating)) or electro\$1plat\$7)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/17 09:34
S1	2	(("6899829") or ("6212769")).PN.	US-PGPUB; USPAT	OR	OFF	2006/03/16 10:37
S2	12	"8900204"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 10:45

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					01:	2006/00/16
<b>S3</b>	842	(electroless near5 plating) and (printed adj (wiring or circuit) adj board) and monomer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 10:53
S4	2	(electroless near5 plating) and (printed adj (wiring or circuit) adj board) and (solution with monomer with seed)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 10:49
S5	213	(electroless near5 plating) and (printed adj (wiring or circuit) adj board) and (solution with monomer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 10:52
S6	92	(electroless near5 plating) and (ptfe or (polytetrafluoroethylene)) and (printed adj (wiring or circuit) adj board) and monomer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 16:59
S7	5	(electroless near5 plating) and ((ptfe or (polytetrafluoroethylene)) near30 (printed adj (wiring or circuit) adj board)) and monomer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 10:57
S8	87	S6 not S7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:05
S9	19	427/96.1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:08
S10	11	427/98.4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:05

•		427/00 5	LIC DCDUD	00	ON	2006/02/16 12:05
S11	3	427/99.5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:05
S12	1560	427/123	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:06
S13	1338	427/304	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:06
S14	1873	427/430.1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:06
S15	860	427/443.1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:06
S16	3	427/98.5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:06
S17	1	427/99.1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:06
S18	3	427/99.4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:06

S19	986	427/305	US-PGPUB;	OR	ON	2006/03/16 13:06
			USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB			
S20	511531	monomer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:08
S21	690	S20 and (S9 or S10 or S11 or S12 or S13 or S14 or S15 or S16 or S17 or S18 or S19)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:09
S22	6	S20 and (S9 or S10 or S11 or S16 or S17 or S18)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:14
S23	221345	ptfe or teflon or polytetrafluoroethylene	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 13:15
S24	304280	(pcb or pwb or (printed adj (wiring or circuit) adj board))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:10
S25	1141	S20 and S23 and S24	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:12
S26	31	S25 and (S12 or S13 or S14 or S15 or S19)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:12

C2-	4 -	C26 not (C0 or C22)	LIC DCDLID.	OR	ON	2006/03/16 14:07
S27	15	S26 not (S8 or S22)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OK	OIV	2000/03/10 14.07
S28	31091	S20 and S23	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:07
S29	7353	S20 and S24	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:15
S30	158	S28 and (S12 or S13 or S14 or S15 or S19)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:08
S31	115	S29 and (S12 or S13 or S14 or S15 or S19)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:16
S32	127	S30 not (S8 or S22 or S26)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:08
S33	83	S31 not (S8 or S22 or S26 or S30)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:08
S34	495651	(pcb or pwb or (printed adj (wiring or circuit) adj board) or printed\$1wiring or printed\$1circuit or ((wiring or circuit) adj board))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:11

S35	1608	S20 and S23 and S34	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:12
S36	35	S35 and (S12 or S13 or S14 or S15 or S19)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:12
<b>S37</b>	4	S36 not S26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:12
S38	10213	S20 and S34	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:16
S39	145	S38 and (S12 or S13 or S14 or S15 or S19)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:17
S40	112	S39 not (S8 or S22 or S26)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:21
S41	123	S30 not (S8 or S22 or S26 or S39)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:17
S42	72	S40 and plating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:22

S43	60	S40 and ((electroless or electrolessly) near5 (plated or plating))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 15:58
S44	12	S42 not S43	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 14:23
S45	1	("4525390").PN.	US-PGPUB; USPAT	OR	OFF	2006/03/16 16:54
S46	1	("6461678").PN.	US-PGPUB; USPAT	OR	OFF	2006/03/16 16:54
S47	4	("5153023"   "5192581"   "5316867"   "5348574").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/03/16 16:54
S48	1	("6461678").URPN.	USPAT	OR	ON	2006/03/16 16:59
S49	180	(ptfe or polytetrafluoroethylene or teflon) and (((electroless or electrolessly) near5 (plated or plating or plate)) near20 copper) and monomer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 17:01
S50	116	S49 not (S6 or S22 or S26 or S36 or S43)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 17:03
S51	52	S50 and ((circuit or wire or wiring or printed) near5 board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/16 17:04

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Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L7	4	((ptfe or teflon or polytetrafluoroethylene) and monomer and (((electro or electroless or electrolessly) near5 (plate or plated or plating)) or electro\$1plat\$7)).clm.	US-PGPUB	OR	ON	2006/03/17 09:51
L8	378	((ptfe or teflon or polytetrafluoroethylene) and monomer).clm.	US-PGPUB	OR	ON	2006/03/17 09:51
L9	2	8 and (156/150-151.ccls. or 427/96.1 or 427/98.4 or 427/98.5 or 427/99.5 or 427/99.1 or 427/123 or 427/304 or 427/443.1 or 427/305)	US-PGPUB	OR	ON	2006/03/17 09:52